

Electronic Patent Application Fee Transmittal**Application Number:** 10566519**Filing Date:** 30-Jan-2006**Title of Invention:** Hot-Press Cushioning Material its Manufacturing Method and Manufacturing Method of Laminated Board**First Named Inventor/Applicant Name:** Akira Yoshida**Filer:** Phouphanomketh Ditthavong/Abigail Feldman**Attorney Docket Number:** 01050-1010

Filed as Large Entity

U.S. National Stage under 35 USC 371 Filing Fees**Description****Fee Code****Quantity****Amount****Sub-Total in
USD(\$)****Basic Filing:****Pages:****Claims:****Miscellaneous-Filing:****Petition:****Patent-Appeals-and-Interference:**

Notice of appeal

1401

1

540

540

Post-Allowance-and-Post-Issuance:**Extension-of-Time:**

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 2 months with \$0 paid	1252	1	490	490
Miscellaneous:				
Total in USD (\$)				1030